

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

David R. Hembree

**Serial No.:** 10/624,332

**Filed:** July 22, 2003

**For:** CHIP ON BOARD AND HEAT SINK  
ATTACHMENT METHODS

**Confirmation No.:** 6977

**Examiner:** C. Lee

**Group Art Unit:** 2812

**Attorney Docket No.:** 2269-3592.8US  
(97-0321.08/US)

**VIA ELECTRONIC FILING**  
**June 26, 2007**

**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES  
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Mail Stop ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

1. This letter is to specify that the FEE ADDRESSEE for this patent is:  

MICRON TECHNOLOGY, INC.  
Mail Stop 525  
8000 South Federal Way  
Boise, Idaho 83707-0006
2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.

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4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "James R. Duzan". The signature is fluid and cursive, with the first name "James" and last name "Duzan" clearly distinguishable.

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JRD/dlm:lmh

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